

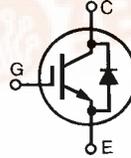


Advance Technical Information

BIMOSFET™ Monolithic Bipolar MOS Transistor

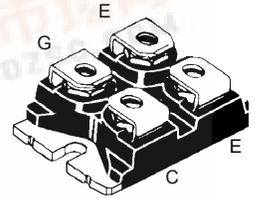
IXBN 75N170A

V_{CES} = 1700 V
I_{C25} = 75 A
V_{CE(sat)} = 6.0 V
t_{fi} = 60 ns



Symbol	Test Conditions	Maximum Ratings
V _{CES}	T _J = 25°C to 150°C	1700 V
V _{CGR}	T _J = 25°C to 150°C; R _{GE} = 1 MΩ	1700 V
V _{GES}	Continuous	±20 V
V _{GEM}	Transient	±30 V
I _{C25}	T _C = 25°C	75 A
I _{C90}	T _C = 90°C	42 A
I _{CM}	T _C = 25°C, 1 ms	240 A
SSOA (RBSOA)	V _{GE} = 15 V, T _{VJ} = 125°C, R _G = 10 Ω Clamped inductive load	I _{CM} = 100 A V _{CES} = 1350 V
T_{SC} (SCSOA)	V _{GE} = 15 V, V _{CES} = 1200V, T _J = 125°C R _G = 10 Ω non repetitive	10 μs
P _C	T _C = 25°C	500 W
T _J		-55 ... +150 °C
T _{JM}		150 °C
T _{stg}		-55 ... +150 °C
M _d	Mounting torque Terminal connection torque (M4)	1.5/13 Nm/lb.in. 1.5/13 Nm/lb.in.
Weight		30 g

miniBLOC, SOT-227 B (IXBN)



G = Gate
E = Emitter

C = Collector

Either Source terminal at miniBLOC can be used as Main or Kelvin Emitter

Features

- High Blocking Voltage
- Fast switching
- High current handling capability
- MOS Gate turn-on - drive simplicity
- Isolation voltage 2500V

Applications

- AC motor speed control
- Uninterruptible power supplies (UPS)
- Switched-mode and resonant-mode power supplies
- Substitutes for high voltage MOSFETs

Advantages

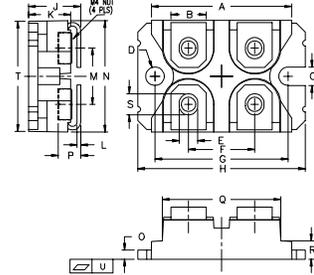
- Lower conduction losses than MOSFETs
- High power density
- Easy to mount with 2 screws
- Space saving

Symbol	Test Conditions	Characteristic Values (T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
BV_{CES}	I _C = 250 μA, V _{GE} = 0 V	1700		V
V_{GE(th)}	I _C = 1500 μA, V _{CE} = V _{GE}	2.5		V
I_{CES}	V _{CE} = 0.8 V _{CES} V _{GE} = 0 V			50 μA 1.5 mA
I_{GES}	V _{CE} = 0 V, V _{GE} = ±20 V			±200 nA
V_{CE(sat)}	I _C = I _{C90} , V _{GE} = 15 V	4.5 5.0	6.0	V V
	T _J = 125°C			



Symbol	Test Conditions	Characteristic Values		
		(T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
g_{fs}	I _C = I _{C90} ; V _{CE} = 10 V, Pulse test, t ≤ 300 μs, duty cycle ≤ 2 %	30	50	S
C_{ies}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		7400	pF
C_{oes}			340	pF
C_{res}			90	pF
Q_g	I _C = I _{C90} , V _{GE} = 15 V, V _{CE} = 0.5 V _{CES}		310	nC
Q_{ge}			60	nC
Q_{gc}			110	nC
t_{d(on)}	Inductive load, T_J = 25°C I _C = I _{C90} , V _{GE} = 15 V V _{CE} = 0.8 V _{CES} , R _G = R _{off} = 1.0 Ω Remarks: Switching times may increase for V _{CE} (Clamp) > 0.8 • V _{CES} , higher T _J or increased R _G		35	ns
t_{ri}			60	ns
t_{d(off)}			240	ns
t_{fi}			60	ns
E_{off}			6.0	mJ
t_{d(on)}	Inductive load, T_J = 125°C I _C = I _{C90} , V _{GE} = 15 V V _{CE} = 0.8 V _{CES} , R _G = R _{off} = 1.0 Ω Remarks: Switching times may increase for V _{CE} (Clamp) > 0.8 • V _{CES} , higher T _J or increased R _G		35	ns
t_{ri}			60	ns
E_{on}			10	mJ
t_{d(off)}			280	ns
t_{fi}			120	ns
E_{off}		12	mJ	
R_{thJC}				0.2 KW
R_{thCK}		0.05		KW

miniBLOC, SOT-227 B



M4 screws (4x) supplied

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Reverse Diode

Symbol	Test Conditions	Characteristic Values		
		(T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
V_F	I _F = I _{C90} , V _{GE} = 0 V, Pulse test, t < 300 μs, duty cycle d < 2%			5.0 V
I_{RM}	I _F = 25A, V _{GE} = 0 V, -di _F /dt = 50 A/μs V _R = 100V		15	A
t_{rr}			330	ns